#### NCE N-Channel Enhancement Mode Power MOSFET

#### **Description**

The NCE0159 uses advanced trench technology and design to provide excellent  $R_{DS(ON)}$  with low gate charge. It can be used in a wide variety of applications.

#### **General Features**

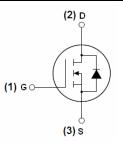
- $V_{DS} = 100V, I_D = 59A$  $R_{DS(ON)} < 15mΩ @ V_{GS} = 10V$  (Typ:11mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E<sub>AS</sub>
- Excellent package for good heat dissipation

### **Application**

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



#### Schematic diagram



#### Marking and pin assignment



TO-220-3L top view

#### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE0159	NCE0159	TO-220-3L	-	-	-

#### Absolute Maximum Ratings (T<sub>C</sub>=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	100	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	59	Α
Drain Current-Continuous(T <sub>C</sub> =100°ℂ)	I <sub>D</sub> (100℃)	42	Α
Pulsed Drain Current	I <sub>DM</sub>	240	Α
Maximum Power Dissipation	P <sub>D</sub>	180	W
Derating factor		1.2	W/℃
Single pulse avalanche energy (Note 5)	E <sub>AS</sub>	580	mJ
Operating Junction and Storage Temperature Range	$T_{J},T_{STG}$	-55 To 175	$^{\circ}$



## **Thermal Characteristic**

Thermal Resistance, Junction-to-Case (Note 2)	$R_{\theta JC}$	0.83	°C/W
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Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

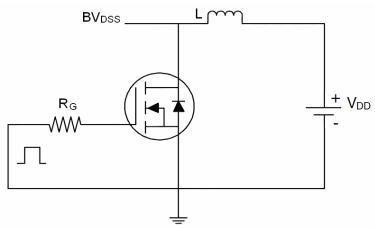
Symbol	Condition	Min	Тур	Max	Unit
BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	100	110	-	V
I <sub>DSS</sub>	V <sub>DS</sub> =100V,V <sub>GS</sub> =0V	-	-	1	μΑ
I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
		•			
V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250μA	2	3	4	V
R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =28A	-	11	15	mΩ
<b>9</b> FS	V <sub>DS</sub> =25V,I <sub>D</sub> =28A	32	-	-	S
C <sub>lss</sub>	\/ -25\/\/ -0\/	-	4900	-	PF
Coss		-	400	-	PF
C <sub>rss</sub>	F=1.0IVID2	-	390	-	PF
		•			
t <sub>d(on)</sub>		-	12	-	nS
t <sub>r</sub>	V <sub>DD</sub> =50V,I <sub>D</sub> =28A	-	55	-	nS
t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{GEN}$ =2.5 $\Omega$	-	45	-	nS
t <sub>f</sub>		-	47	-	nS
Qg	\/ -00\/ L -20A	-	95	-	nC
Q <sub>gs</sub>		-	18	-	nC
$Q_{gd}$	V <sub>GS</sub> -10V	-	25	-	nC
V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =59A	-	0.85	1.2	V
Is	-	-	-	59	Α
t <sub>rr</sub>	TJ = 25°C, IF = 59A	-	37	-	nS
Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	58	-	nC
	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				
	BVDSS IDSS IDSS IGSS VGS(th) RDS(ON) GFS  Class Crss  td(on) tr td(off) tf Qg Qgs Qgd  VSD IS trr	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	Symbol         Condition         Min           BV <sub>DSS</sub> V <sub>GS</sub> =0V I <sub>D</sub> =250µA         100           I <sub>DSS</sub> V <sub>DS</sub> =100V,V <sub>GS</sub> =0V         -           I <sub>GSS</sub> V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V         -           V <sub>GS</sub> (th)         V <sub>DS</sub> =250,I <sub>D</sub> =250µA         2           R <sub>DS</sub> (ON)         V <sub>GS</sub> =10V, I <sub>D</sub> =28A         -           G <sub>PS</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -           C <sub>OSS</sub> C <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -           C <sub>OSS</sub> C <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -           C <sub>OSS</sub> C <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=28A         -           C <sub>OSS</sub> C <sub>DS</sub> =10V,R <sub>GEN</sub> =2.5Ω         -           C <sub>DS</sub> =10V,R <sub>GEN</sub> =2.5Ω         -         -           C <sub>OSS</sub> C <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -           C <sub>OSS</sub> C <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -           C <sub>OSS</sub> C <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -           C <sub>OSS</sub> C <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -           C <sub>OSS</sub> C <sub>DS</sub> =10V         -	Symbol         Condition         Min         Typ           BV <sub>DSS</sub> V <sub>GS</sub> =0V I <sub>D</sub> =250µA         100         110           I <sub>DSS</sub> V <sub>DS</sub> =100V,V <sub>GS</sub> =0V         -         -           I <sub>GSS</sub> V <sub>GS</sub> ±20V,V <sub>DS</sub> =0V         -         -           V <sub>GS</sub> (th)         V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA         2         3           R <sub>DS</sub> (ON)         V <sub>GS</sub> =10V, I <sub>D</sub> =28A         -         11           g <sub>FS</sub> V <sub>DS</sub> =25V,I <sub>D</sub> =28A         -         4900           C <sub>ISS</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -         4900           C <sub>OSS</sub> C <sub>TSS</sub> -         4900           C <sub>ISS</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -         12           t <sub>T</sub> V <sub>DS</sub> =25V,I <sub>D</sub> =28A         -         55           V <sub>GS</sub> =10V,R <sub>GEN</sub> =2.5Ω         -         45         -           t <sub>f</sub> V <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -         95         -           Q <sub>g</sub> V <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -         18         -         -         25           V <sub>SD</sub> V <sub>GS</sub> =0V,I <sub>S</sub> =59A         -         0.85         -         -         -         -         -         -         -         -         -	Symbol         Condition         Min         Typ         Max           BV <sub>DSS</sub> V <sub>GS</sub> =0V I <sub>D</sub> =250µA         100         110         -           I <sub>DSS</sub> V <sub>DS</sub> =100V,V <sub>DS</sub> =0V         -         -         1           I <sub>DSS</sub> V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V         -         -         ±100           V <sub>GS</sub> (th)         V <sub>DS</sub> =V <sub>GS</sub> ,I <sub>D</sub> =250µA         2         3         4           R <sub>DS</sub> (ON)         V <sub>GS</sub> =10V, I <sub>D</sub> =28A         -         11         15           g <sub>FS</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -         4900         -           C <sub>OSS</sub> C <sub>CSS</sub> -         4900         -           C <sub>OSS</sub> C <sub>TSS</sub> -         4900         -           C <sub>OSS</sub> C <sub>TS</sub> -         4900         -           C <sub>TSS</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -         12         -           t <sub>T</sub> V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz         -         12         -           L <sub>G</sub> (on)         V <sub>GS</sub> =10V,R <sub>GEN</sub> =2.5Ω         -         45         -           t <sub>T</sub> V <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -         95         -           Q <sub>G</sub> V <sub>DS</sub> =80V,I <sub>D</sub> =28A, V <sub>GS</sub> =10V         -

#### Notes:

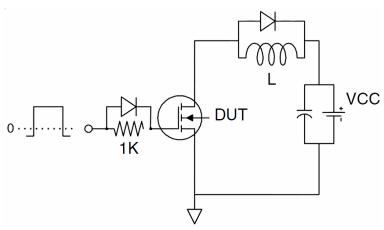
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- **5.** EAS condition: Tj=25 $^{\circ}$ C,V<sub>DD</sub>=50V,V<sub>G</sub>=10V,L=0.5mH,Rg=25 $\Omega$

## **Test Circuit**

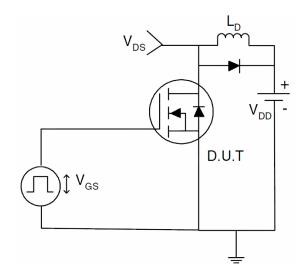
## 1) E<sub>AS</sub> test Circuit



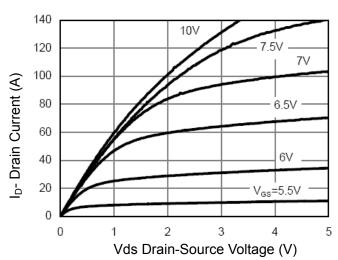
## 2) Gate charge test Circuit



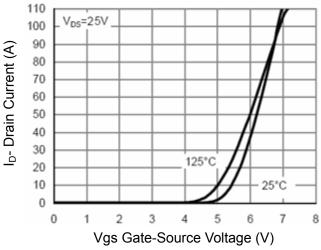
#### 3) Switch Time Test Circuit



## **Typical Electrical and Thermal Characteristics (Curves)**



**Figure 1 Output Characteristics** 



**Figure 2 Transfer Characteristics** 

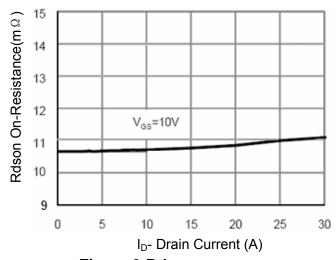


Figure 3 Rdson- Drain Current

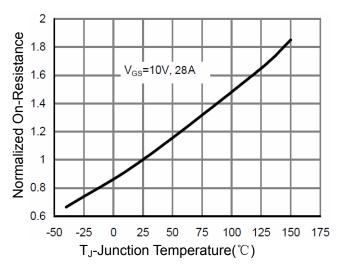


Figure 4 Rdson-JunctionTemperature

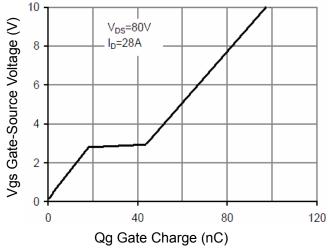
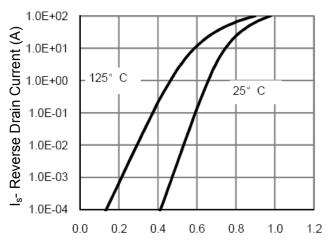


Figure 5 Gate Charge



Vsd Source-Drain Voltage (V)

Figure 6 Source- Drain Diode Forward

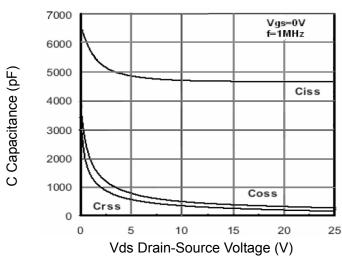
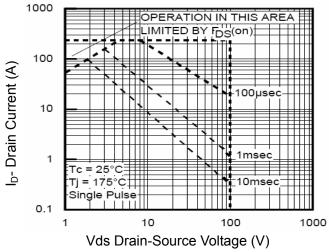


Figure 7 Capacitance vs Vds



**Figure 8 Safe Operation Area** 

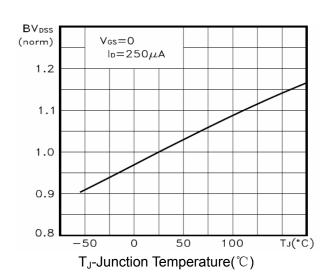


Figure 9 BV<sub>DSS</sub> vs Junction Temperature

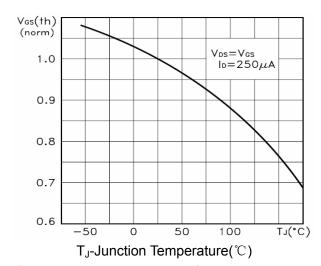


Figure 10 V<sub>GS(th)</sub> vs Junction Temperature

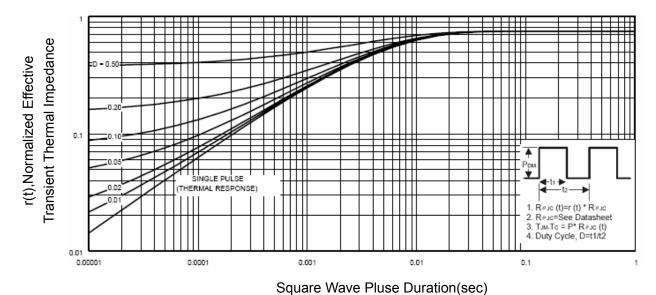
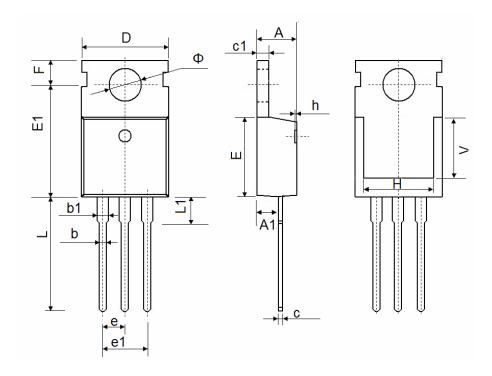


Figure 11 Normalized Maximum Transient Thermal Impedance

# **TO-220-3L Package Information**



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
Е	8.9500	9.750	0.352	0.384	
E1	12.650	12.950	0.498	0.510	
е	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	7.500 REF.		00 REF. 0.295 REF.		
Ф	3.400	3.800	0.134	0.150	

**NCE0159** 

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